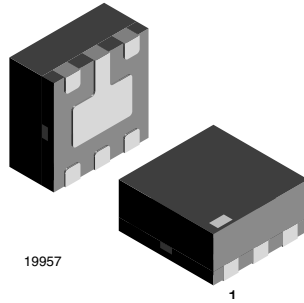
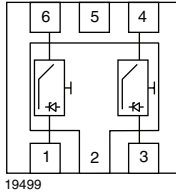


2-Channel EMI-Filter with ESD-Protection

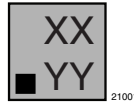


FEATURES

- Ultra compact LLP75-6A package
- 2-channel EMI-filter and ESD-protection
- Low leakage current
- Line resistance $R_S = 50 \Omega$
- Typical cut off frequency $f_{3dB} = 100 \text{ MHz}$
- ESD-protection acc. IEC 61000-4-2
 $\pm 30 \text{ kV}$ contact discharge
 $\pm 30 \text{ kV}$ air discharge
- e3 - Sn
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



MARKING (example only)



Dot = pin 1 marking

YY = type code (see table below)

XX = date code

ORDERING INFORMATION

DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL (8 mm TAPE ON 7" REEL)	MINIMUM ORDER QUANTITY
VEMI255A-HS3	VEMI255A-HS3-GS08	3000	15 000
VEMI255A-HS3	VEMI255A-HS3-GS08	10 000	10 000

PACKAGE DATA

DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
VEMI255A-HS3	LLP75-6A	T1	5 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

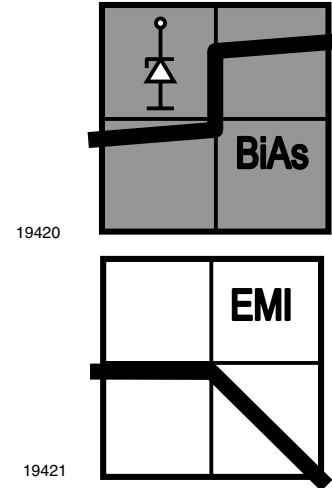
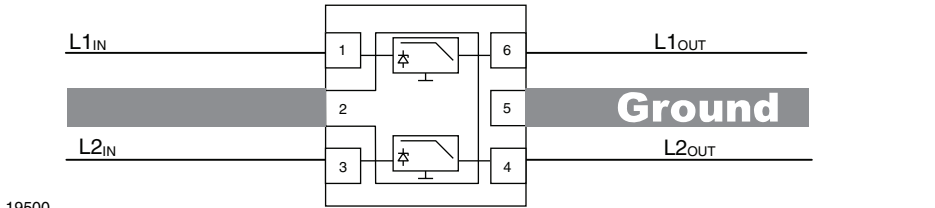
ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	All I/O pin to pin 2; acc. IEC 61000-4-5; $t_p = 8/20 \mu\text{s}$; single shot	I_{PPM}	4	A
ESD immunity	Contact discharge acc. IEC61000-4-2; 10 pulses	V_{ESD}	± 30	kV
	Air discharge acc. IEC61000-4-2; 10 pulses		± 30	
Operating temperature	Junction temperature	T_J	- 40 to + 125	°C
Storage temperature		T_{STG}	- 55 to + 150	°C

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATION NOTE

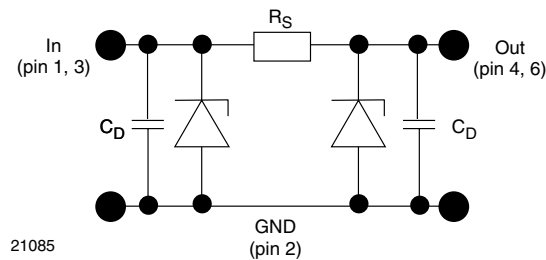
With the VEMI255A-HS3 2 different signal or data lines can be filtered and clamped to ground. Due to the different clamping levels in forward and reverse direction the clamping behavior is Bidirectional and Asymmetric (BiAs).



The 2 independent EMI-filter are placed between pin 1 and pin 6, and pin 3 and pin 4.

They all are connected to the common ground pin 2. Pin 5 is internally not connected. Each filter is symmetrical so that all ports (pin 1, 3, 4, and 6) can be used as input or output.

The circuit diagram of one EMI-filter-channel shows two identical Z-diodes at the input to ground and the output to ground. These Z-diodes are characterized by the breakthrough voltage level (V_{BR}) and the diode capacitance (C_D). Below the breakthrough voltage level the Z-diodes can be considered as capacitors. Together with these capacitors and the line resistance R_S between input and output the device works as a low pass filter. Low frequency signals ($f < f_{3dB}$) pass the filter while high frequency signals ($f > f_{3dB}$) will be shorted to ground through the diode capacitances C_D .



Each filter is symmetrical so that both ports can be used as input or output.

ELECTRICAL CHARACTERISTICS VEMI255A-HS3						
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of channels which can be protected	$N_{channel}$	-	-	2	channel
Reverse stand off voltage	at $I_R = 1 \mu A$ each input to pin 2	V_{RWM}	5	-	-	V
Reverse current	at $V_R = 5 V$ each input to pin 2	I_R	-	-	1	μA
Reverse break down voltage	Each input to pin 2 at $I_R = 1 mA$	V_{BR}	6	-	-	V
Pos. clamping voltage	at $I_{PP} = 1 A$ applied at the input, measured at the output; acc. IEC 61000-4-5	V_{C-out}	-	-	7.8	V
	at $I_{PP} = I_{PPM} = 4 A$ applied at the input, measured at the output; acc. IEC 61000-4-5	V_{C-out}	-	-	8	V
Neg. clamping voltage	at $I_{PP} = -1 A$ applied at the input, measured at the output; acc. IEC 61000-4-5	V_{C-out}	- 1	-	-	V
	at $I_{PP} = I_{PPM} = -4 A$ applied at the input, measured at the output; acc. IEC 61000-4-5	V_{C-out}	- 1.2	-	-	V
Input capacitance	at $V_R = 0 V$; $f = 1 MHz$	C_{IN}	-	60	-	pF
	at $V_R = 2.5 V$; $f = 1 MHz$	C_{IN}	-	37	-	pF
ESD-clamping voltage	at $\pm 30 kV$ ESD-pulse acc. IEC 61000-4-2	V_{CESD}	-	7.5	-	V
Line resistance	Measured between input and output; $I_S = 10 mA$	R_S	45	50	55	Ω
Cut-off frequency	$V_{IN} = 0 V$; measured in a 50Ω system	f_{3dB}	-	100	-	MHz

Note

Ratings at 25 °C, ambient temperature unless otherwise specified.

TYPICAL CHARACTERISTICS

$T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified

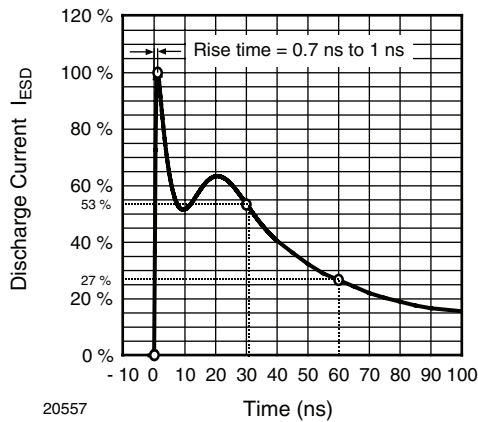


Fig. 1 - ESD Discharge Current Wave Form
acc. IEC 61000-4-2 (330 Ω /150 pF)

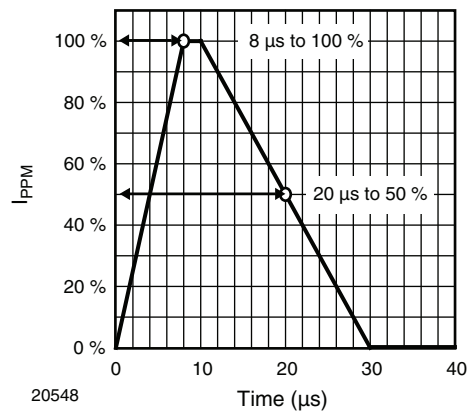


Fig. 2 - 8/20 μs Peak Pulse Current Wave Form
acc. IEC 61000-4-5

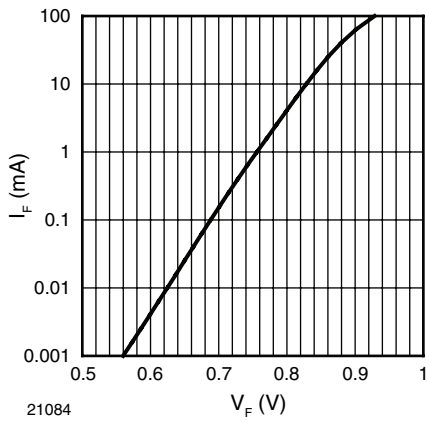


Fig. 3 - Typical Forward Current I_F vs. Forward Voltage V_F

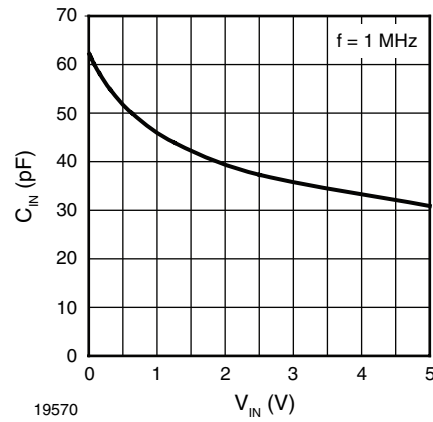


Fig. 6 - Typical Input Capacitance C_{IN} vs. Input Voltage V_{IN}

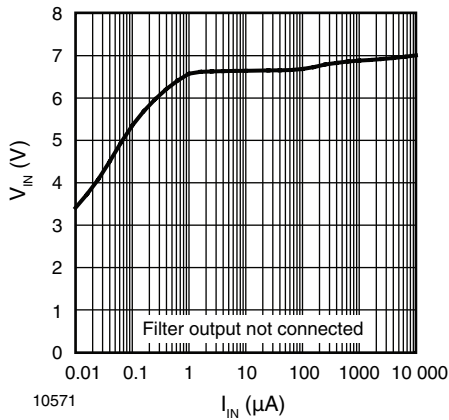


Fig. 4 - Typical Input Voltage V_{IN} vs. Input Current I_{IN}

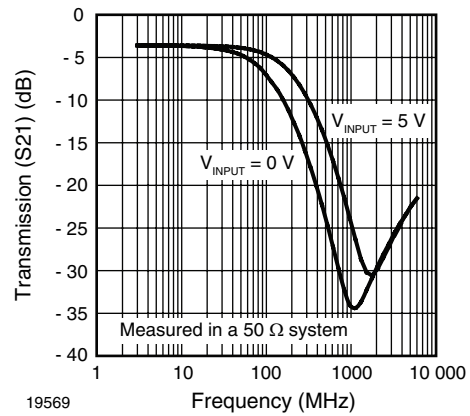


Fig. 7 - Typical Small Signal Transmission (S21) at $Z_O = 50 \Omega$

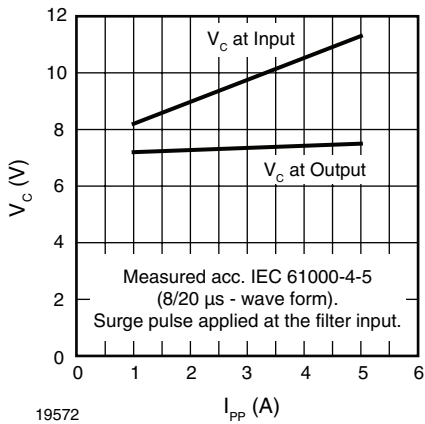


Fig. 5 - Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}



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